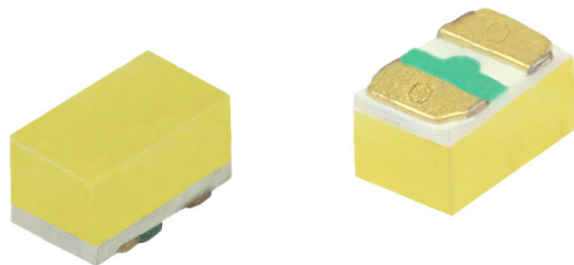


Highbright 0201 ChipLED



DESCRIPTION

The 0201 ChipLED delivers brilliant illumination in one of the smallest surface-mount formats available. Measuring just 0.65 mm x 0.375 mm x 0.35 mm, it is perfectly suited for space-constrained applications in consumer electronics, wearables, industrial systems, and more. This RoHS-compliant component combines ultra compact dimensions, low power consumption, a wide viewing angle, and multiple color options engineered for seamless integration into automated SMT processes. Offering exceptional versatility and performance, the 0201 ChipLED empowers the next generation of compact, high efficiency electronic designs.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD 0201 ChipLED
- Product series: standard
- Angle of half intensity: $\pm 60^\circ$

FEATURES

- Super small ChipLED with high brightness 0.65 x 0.375 x 0.35 (L x W x H in mm)
- High reliability PCB based
- Typical color coordinates: x, y = 0.3, 0.3
- High efficient InGaN technology
- Wide viewing angle: 120°
- Grouping parameter: luminous intensity, CIE 1931 chromaticity coordinates, and forward voltage
- Available in 8 mm tape on 7" diameter reel
- ESD sensitive device, HBM 1000 V
- Compatible to IR reflow soldering
- Preconditioning according to JEDEC® level 3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Backlighting for keypads, logos, and buttons in ultra-thin devices
- Instrument illumination
- Indicators and backlight for telecommunication equipment, consumer electronics, and white goods
- Displays for industrial control systems
- Next-generation compact devices and smart accessories
- General use

PARTS TABLE

PART	COLOR	LUMINOUS INTENSITY (mcd)			at I _F (mA)	COLOR COORDINATES (x, y)			at I _F (mA)	FORWARD VOLTAGE (V)			at I _F (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMW1700-GS08	White	36	-	90	2	-	0.3, 0.3	-	2	2.5	-	2.9	2	InGaN / sapphire

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified) VLMW170. (InGaN technology)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ⁽¹⁾		V _R	5	V
DC forward current		I _F	10	mA
Surge forward current	1/10 duty cycle, 0.1 ms pulse width	I _{FSM}	20	mA
Power dissipation	T _{amb} ≤ 25 °C	P _V	30	mW
Operating temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +90	°C
ESD withstand voltage	HBM	V _{ESD}	1000	V
Reflow solder conditions	According Vishay specifications	T _{slid}	260	°C

Note

⁽¹⁾ Reverse voltage is intended for test purposes only; do not operate the device under reverse bias

**OPTICAL AND ELECTRICAL CHARACTERISTICS** ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)
VLMW170., WHITE

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity	$I_F = 2\text{ mA}$	I_V	36	-	90	mcd
CIE 1931 chromaticity coordinates x, y	$I_F = 2\text{ mA}$	λ_d	-	0.3, 0.3	-	nm
Angle of half intensity	$I_F = 2\text{ mA}$	φ	-	± 60	-	$^{\circ}$
Forward voltage	$I_F = 2\text{ mA}$	V_F	2.5	-	2.9	V
Reverse current	$V_R = 5\text{ V}$	I_R	-	-	50	μA

**LUMINOUS INTENSITY CLASSIFICATION
AT 2 mA**

GROUP	LUMINOUS INTENSITY (mcd)	
	MIN.	MAX.
N2	36	45
P1	45	57
P2	57	72
Q1	72	90

Note

- Tolerance of luminous intensity: $\pm 11\%$

**FORWARD VOLTAGE CLASSIFICATION
AT 2 mA**

GROUP	FORWARD VOLTAGE (V)	
	MIN.	MAX.
27	2.5	2.6
28	2.6	2.7
29	2.7	2.8
30	2.8	2.9

Note

- Tolerance of forward voltage: $\pm 0.05\text{ V}$

**CIE 1931 COLOR CLASSIFICATION
AT 2 mA**

GROUP	X	Y
1	0.274	0.226
	0.274	0.258
	0.294	0.286
	0.294	0.254
2	0.274	0.258
	0.274	0.291
	0.294	0.319
	0.294	0.286
3	0.294	0.254
	0.294	0.286
	0.314	0.315
	0.314	0.282
4	0.294	0.286
	0.294	0.319
	0.314	0.347
	0.314	0.315
5	0.314	0.282
	0.314	0.315
	0.334	0.343
	0.334	0.311
6	0.314	0.315
	0.314	0.347
	0.334	0.376
	0.334	0.343

Note

- Tolerance of chromaticity coordinate groups: ± 0.01

Notes

- In order to ensure availability, single groups for luminous intensity, color, and forward voltage will not be orderable
- Only one group for luminous intensity, dominant wavelength, and forward voltage will be shipped in any one reel

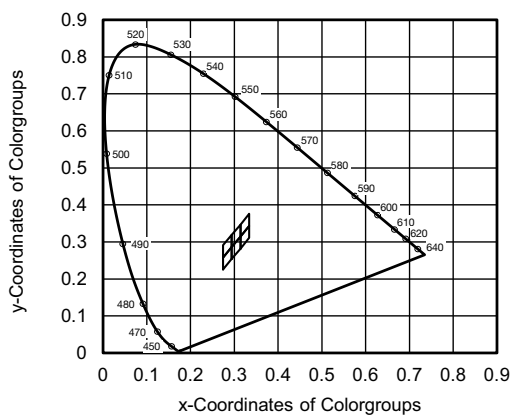
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Coordinates of Color Groups VLMW1700

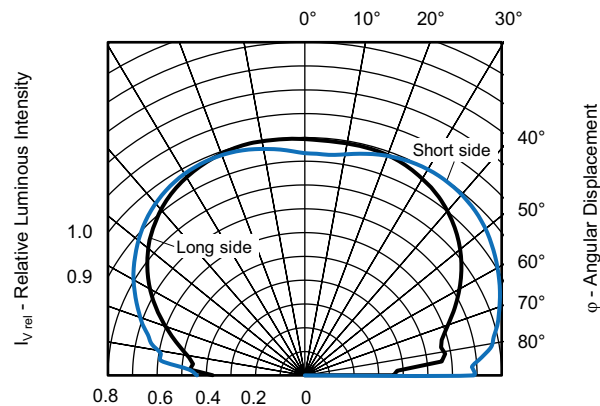


Fig. 4 - Relative Luminous Intensity vs. Angular Displacement

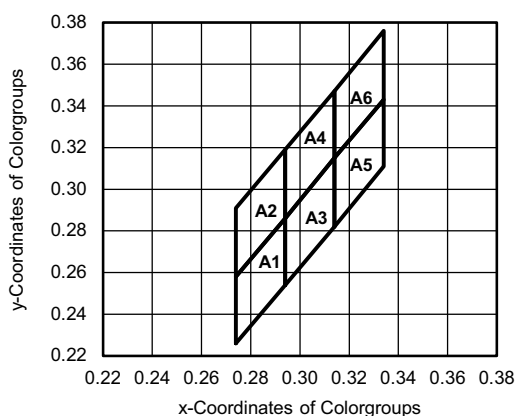


Fig. 2 - Coordinates of Color Groups VLMW1700

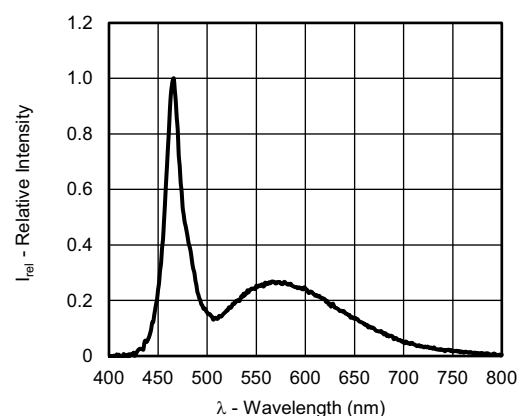


Fig. 5 - Relative Intensity vs. Wavelength

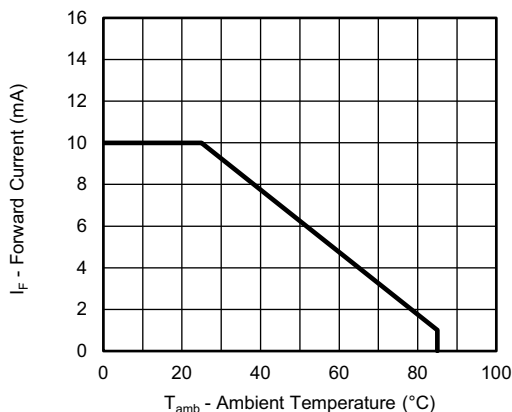


Fig. 3 - Forward Current vs. Ambient Temperature

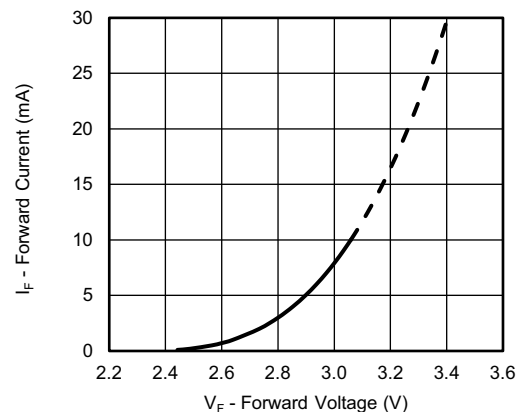


Fig. 6 - Forward Current vs. Forward Voltage

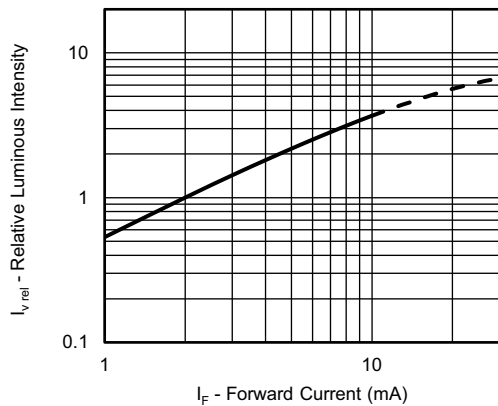


Fig. 7 - Relative Luminous Intensity vs. Forward Current

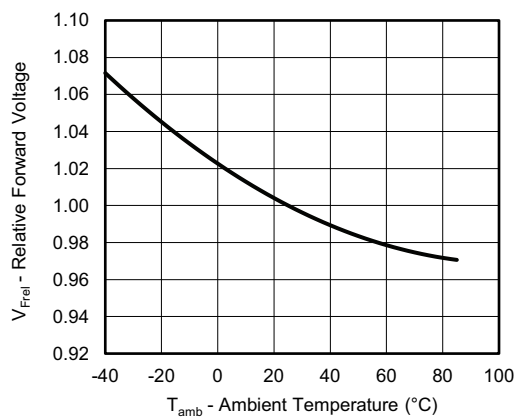


Fig. 8 - Relative Forward Voltage vs. Ambient Temperature

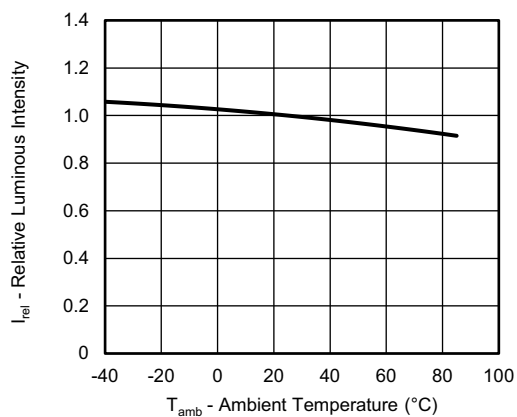
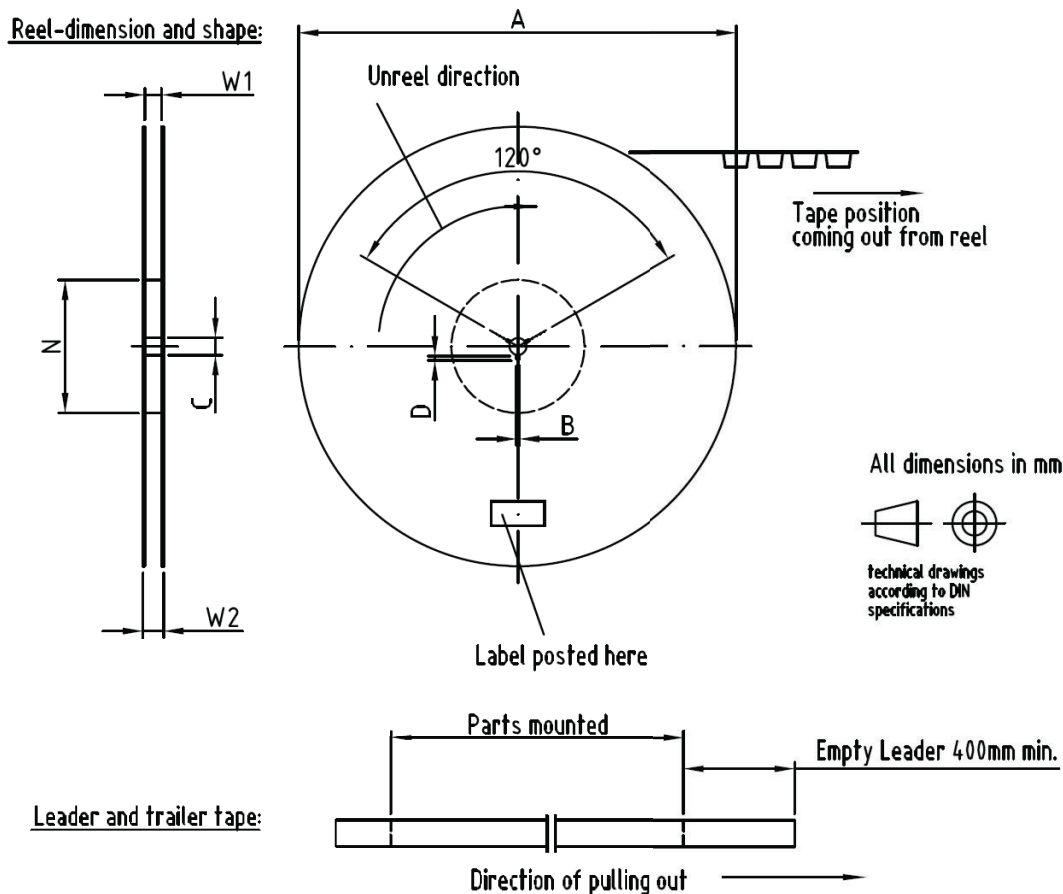


Fig. 9 - Relative Luminous Intensity vs. Ambient Temperature

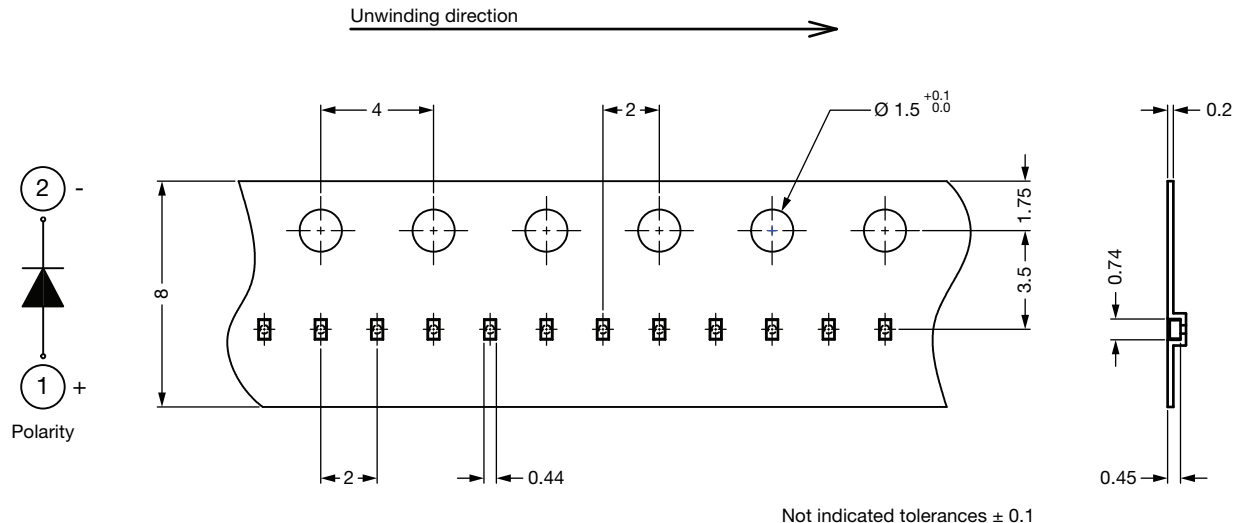
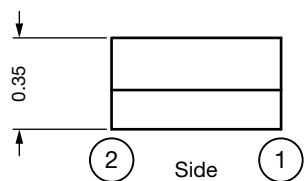
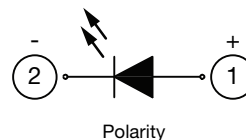
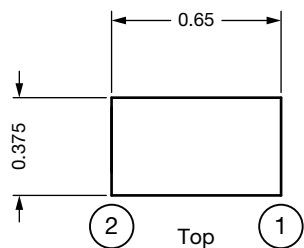
REEL DIMENSIONS in millimeters


Drawing-No.: 9.800-5172.01

Issue: VK; 18.04.24

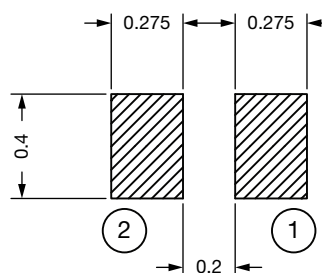
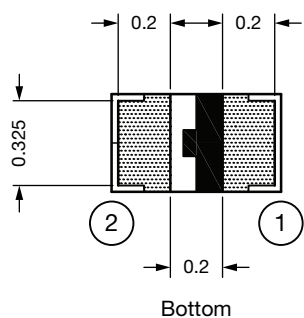
DIMENSIONS OF REEL in millimeters (according drawing reference)							
TAPING VERSION	A	B	C	D	N	W1	W2
GS08	$\varnothing 180 \pm 2$	2 ± 0.5	$\varnothing 13 \pm 0.2$	-	$\varnothing 60 + 0 / - 1$	$9 + 0.3 / - 0$	11.4 ± 1

Reels come in quantity of 3000 units.

TAPE DIMENSIONS in millimeters

PACKAGE DIMENSIONS in millimeters


Not indicated tolerances ± 0.1

Recommended solder pad


Note

- Suggested pad dimensions for reference only; please modify the pad dimensions based on individual need

SOLDERING PROFILE

IR Reflow Soldering Profile for lead (Pb)-free Soldering
Preconditioning acc. to JEDEC Level 3

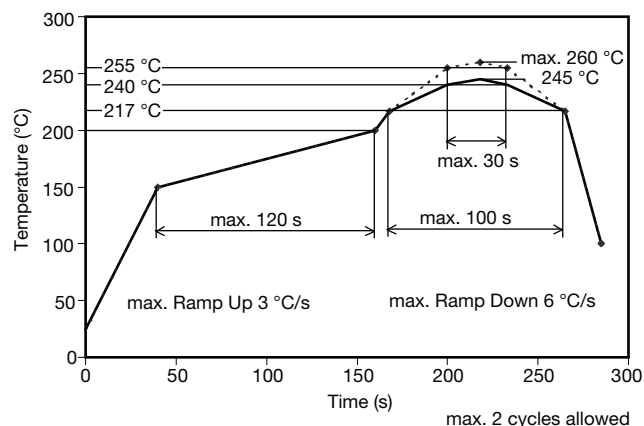
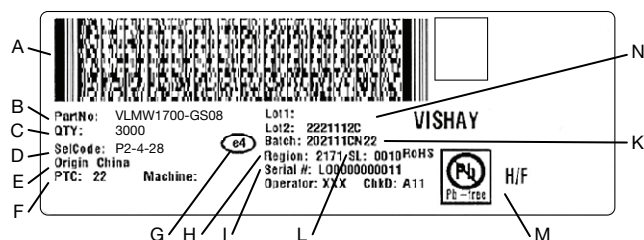


Fig. 10 - Vishay Lead (Pb)-free Reflow Soldering Profile
(according to J-STD-020C)

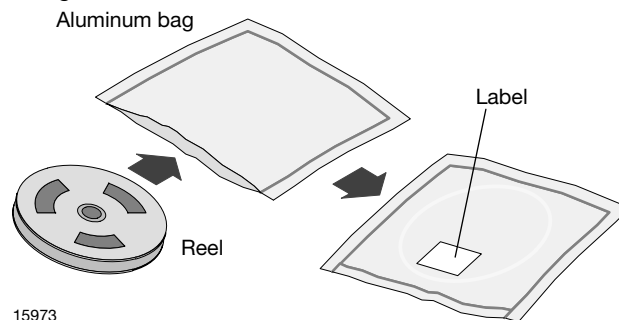
BAR CODE PRODUCT LABEL (Example only)



- A. 2D barcode
- B. Part No: Vishay part number
- C. QTY: quantity
- D. SelCode: selection bin code
- E. Country of origin
- F. PTC: product plant code
- G. Termination finish
- H. Region code
- I. Serial#: serial number
- K. Batch Number: year, week, country code, plant code
- L. SL: storage location
- M. Environmental Symbols: RoHS, lead (Pb)-free, halogen-free
- N. Lot numbers

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the condition given in J-STD-033.

A JEDEC J-STD-033 level 3 label is included on all aluminum dry bags.



Example of JEDEC J-STD-033 Level 3 Label



ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.